Intel® TRN4035BS 10Gbps Optical Serializer/Deserializer Transceiver

16-Channel 622Mbps Multiplexer/Demultiplexer

Product Overview

The Intel® TRN4035BS line of 10Gbps Serializer/Deserializer (SerDes) transceivers is designed to provide a SONET/SDH-compliant interface between the photonic physical layer and the electrical section layer. The module is comprised of an optical transmitter and receiver pair integrated with electrical Multiplexer (MUX) and Demultiplexer (DeMUX) functions. The transmitter section MUXs 16 channels at 622Mbps from a differential Low Voltage Differential Signaling (LVDS) parallel data bus into a 9.95328Gbps optical signal launched into a single-mode optical fiber pigtail. The receiver section DeMUXs a single 9.95328Gbps optical signal back to 16-channel parallel 622Mbps differential LVDS electrical signals. The receiver includes a photodiode, transimpedance amplifier, clock data recovery, decision circuit, and DeMUX. The receiver operates over both 1310nm and 1550nm bands and is compliant with SONET/SDH OC-192/STM 64 physical layer specifications. A block diagram of the module is provided on the reverse side.

The SerDes transceiver is assembled in a Multi-Source Agreement (MSA)-compatible 4.0" L x 3.5" W x 0.53" H package. The heat sinking was designed for 55°C ambient temperature/200 linear feet per minute airflow, with alternative heat sinking options also available. The LVDS interface connection is made using an MSA-compliant 300-pin Berg* MEG-array connector with standard pin-out. Optical connections are made with standard SC-UPC, FC-UPC, or LC-UPC optical connectors.



Both short and intermediate reach versions are compliant with Telcordia GR-253 requirements for OC-192 SONET interfaces. The short reach versions are intended for link spans of 2km or 12km, using a 1310nm Distributed Feedback laser source and a PIN photodetector. The intermediate reach version is intended for link spans up to 40km and uses a 1550nm Externally Modulated Laser as the transmitter and a PIN photodetector as the receiver.

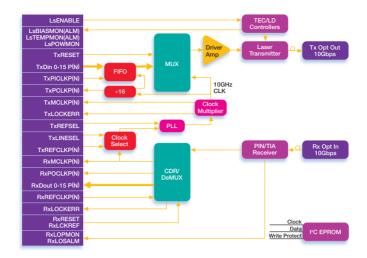
Applications

OC-192 SONET/SDH equipment, including:

- Optical switches and routers
- Cross connects
- Add/drop MUXs
- Dense wavelength division multiplex terminals
- Other WDM and non-WDM metro system equipment
- Optical test equipment



TRN4035BS Serializer/Deserializer Transceiver Block Diagram



Features

- 10Gbps optical transmitter and receiver pair with 16-channel 622Mbps MUX/DeMUX
- Available in short reach (2km) and intermediate reach (40km) versions
- Multi-source agreement compatible form factor and pin configuration
- LVDS data interface via 300-pin Berg* MEG-array connector
- Integral heat sinking designed for 200 linear feet per minute, 55°C ambient airflow; optional heat sinks for higher temperature and/or lower airflow conditions
- Laser bias, laser temperature, laser power, and receiver power monitors
- Rx and Tx loss of lock, Rx loss of signal, laser bias, and laser temperature alarms
- Integrated power supply sequencing

Support Collateral/Tools

 Item
 Description
 Order Number

 Evaluation Board
 ■ Intel® EVL4035BS-002 Evaluation Board
 Contact local sales rep

Intel Advantage

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